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Purpose and Scope

The objectives of *Composites Technology Review* are (1) to provide a forum for the presentation, discussion, and dissemination of information on composite materials and their response to the environments in which they are used, especially the engineering and technology of their application to components and structures, and (2) to provide a means of communication for researchers, developers, producers, users, suppliers, and professional organizations concerned with composite materials.

The editorial scope includes full-length technical articles, technical notes (Composites Review), preliminary technical communications (Research Briefs), news articles and announcements (World of Composites), book reviews, letters, and discussions of previously published work.

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In Appreciation

The high quality of the technical papers in this publication is a tribute not only to the obvious efforts of the authors represented but also to the unheralded, though essential, efforts of their reviewers. It is to the reviewers' dedication to upholding the high standards of their profession that this note pays tribute. On behalf of ASTM and the authors as well, we acknowledge with appreciation their important contribution to the success of this journal.



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